## SUBMINIATURE SOLID STATE LAMP

Green

PRELIMINARY SPEC



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE

**DEVICES** 

Part Number: AM27ZGC09

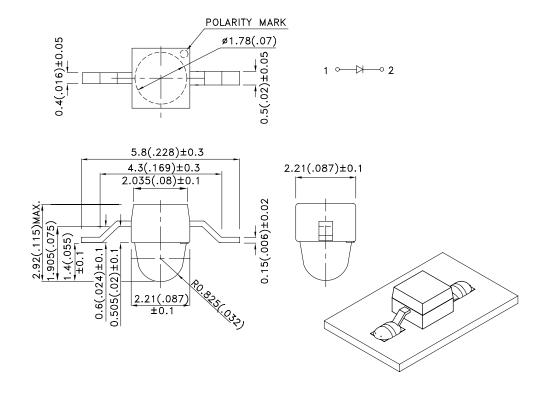
### **Features**

- SUBMINIATURE PACKAGE.
- WIDE VIEWING ANGLE.
- Z-BEND LEAD.
- LONG LIFE SOLID STATE RELIABILITY.
- LOW PACKAGE PROFILE.
- PACKAGE :1000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

### Description

The Green source color devices are made with AllnGaN on Sapphire Light Emitting Diode.
Static electricity and surge damage the LEDS. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
All devices, equipment and machinery must be electrically grounded.

## **Package Dimensions**



### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.
- 5. The device has a single mounting surface. The device must be mounted according to the specifications.





 SPEC NO: DSAH3722
 REV NO: V.1
 DATE: APR/27/2007
 PAGE: 1 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.L.LI
 ERP: 1202001591

## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		,	Min.	Тур.	201/2
AM27ZGC09	Green (AllnGaN)	WATER CLEAR	1800	3300	20°

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
IR	Reverse Current	Green		10	uA	V <sub>R</sub> =5V

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

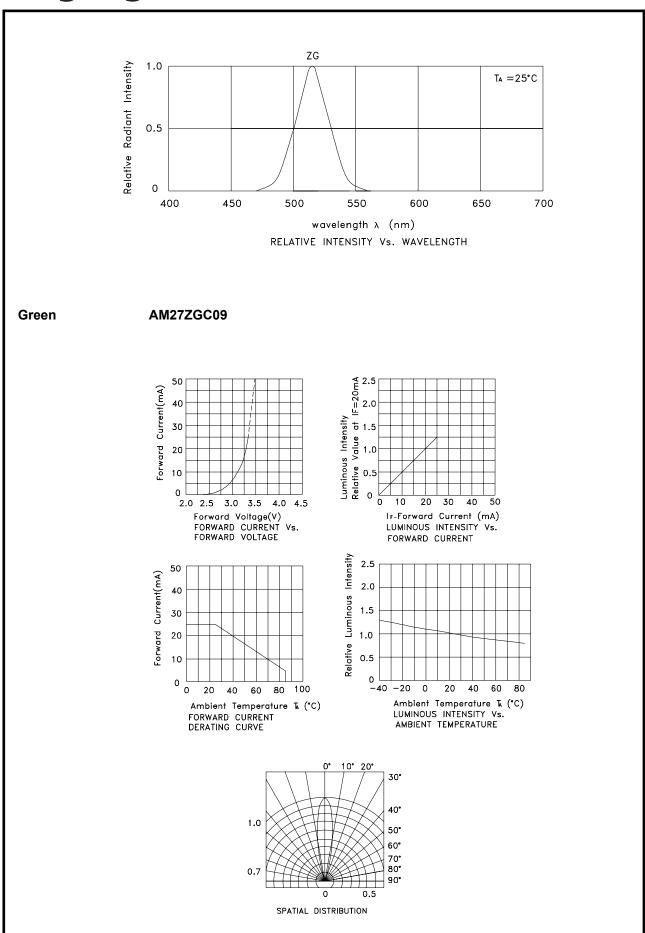
## Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

## Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAH3722 **REV NO: V.1** DATE: APR/27/2007 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.L.LI ERP: 1202001591

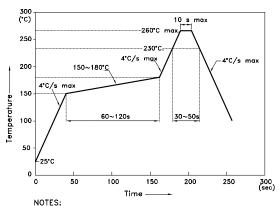


 SPEC NO: DSAH3722
 REV NO: V.1
 DATE: APR/27/2007
 PAGE: 3 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: Y.L.LI
 ERP: 1202001591

## AM27ZGC09

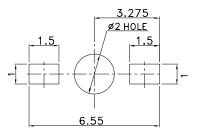
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

## **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



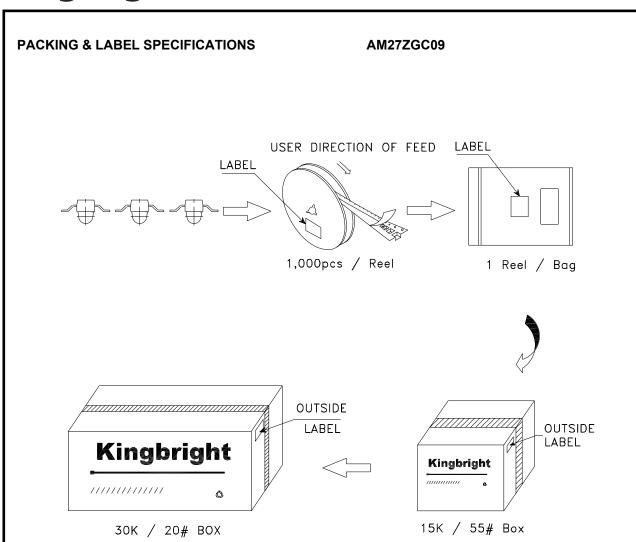
## **Tape Specifications** (Units: mm)

TAPE  $1.75\pm0.1$ 4.0±0.05 2±0.05 4.0±0.1 0.3±0.05  $3.18 \pm 0.1$ 5±0.05  $12\pm0.2$  $1.85 \pm 0.1$ 0.9±0.1 A-A SECTION

SPEC NO: DSAH3722 **APPROVED: WYNEC** 

**REV NO: V.1 CHECKED: Allen Liu**  DATE: APR/27/2007 DRAWN: Y.L.LI

PAGE: 4 OF 5 ERP: 1202001591





SPEC NO: DSAH3722 APPROVED: WYNEC REV NO: V.1 CHECKED: Allen Liu DATE: APR/27/2007 DRAWN: Y.L.LI PAGE: 5 OF 5 ERP: 1202001591